



Figure 1. The Photos of Actual AGDT350V2KAS1812

# **KEY FEATURES**

- Fast Response Time for Reliable Protection
- Stable and Depenable Operation without Aging
- High Current Capability for Variety of Applications
- Low Capacitance and High Insulation Resistance to Minimize Burden to the Signal
- RoHS & REACH Compliant

## **APPLICATIONS**

- Broadband Devices
- CATV and Satellite Equipment
- MDF (Main Distribution Frame) Module
- Base Station and Antenna
- XDSL (X Digital Subscriber Line) Modems
- Power Supply and RF Systems
- Consumer Electronics
- N-PE (Neutral and Protective Earth) Mode Protection in AC Power Systems

### DESCRIPTION

A gas discharge tube (GDT) is a type of protective device consisting of metal electrodes and metallized ceramics enclosed in a sealed space. It is filled with a discharge medium, such as an inert gas or gas mixture, at varying atmospheric pressures to create a single-gap or multi-gap switch. GDTs are designed to protect electronic equipment and systems from voltage surges or transients by providing a low-impedance discharge path.

GDTs have a high insulation resistance, low capacitance, and minimal leakage, ensuring that they have little to no impact on the normal operation of equipment. They are widely used in surge protectors, lightning arrestors, telecommunications systems, power distribution, automotive electronics, medical devices, industrial controls, and aerospace and defense applications.

## Using AGDT350V2KAS1812

1. To ensure safe operation, do not use a gas discharge tube (GDT) in power supply networks where the maximum voltage exceeds the minimum spark-over voltage of the GDT.

 Prolonged current stress may cause the GDT to become hot and pose a burn risk. Overload may cause the connectors to fail or the component to be destroyed.
Defective contacts on surge arresters can lead to sparks and loud noises under current load.

4. The GDT is designed to operate in a range of air pressure between 55kPa to 106kPa, which corresponds to an altitude of +5000m to -500m, respectively.

5. The packaged GDT should be stored in a dry, ventilated, and non-corrosive environment to ensure optimal performance.

6. To avoid electrical shock, do not install the GDT in a location where it can be touched by humans.

7. When assembling, avoid violent actions such as knocking that may cause product failure.

# **AGENCY APPROVALS**

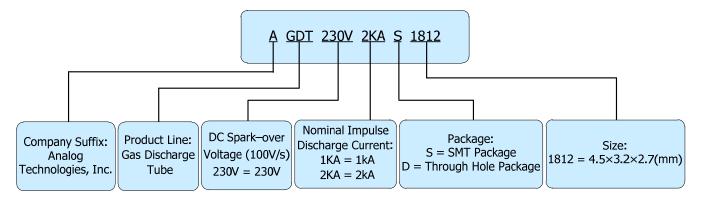
Agency	Standard	File Number		
RI®	UL497B	E513446		
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Analog Technologies \_\_\_\_\_\_ We have been proudly serving you since 1997 Gas Discharge Tube

AGDT350V2KAS1812

# NAMING PRINCIPLE



Naming Principle of AGDT350V2KAS1812

# **SPECIFICATIONS**

#### Table 1. Specifications for AGDT350V2KAS1812 Families

	Spark	DC -over \	/oltage	Impulse Spark-over Voltage	Arc Voltage	AC Discharge Current	Insul Resis		Capacitance	Max Impulse Discharge Current
Part Number @100V/µs		μs	@1000V/µs	@1A	@50Hz, 1s	V <sub>DC</sub>	IR	0.5VDC @1MHz	@8/20µs	
		V		V	v	Α	v	GΩ	pF	kA
	Min	Тур	Мах	Max	Тур	-	-	Min	Max	Max
AGDT90V1KAS1812	72	90	108	600	8	1	50	1	0.6	1
AGDT150V1KAS1812	120	150	180	600	8	1	50	1	0.6	1
AGDT200V1KAS1812	160	200	240	700	10	1	100	1	0.6	1
AGDT230V1KAS1812	184	230	280	700	10	1	100	1	0.6	1
AGDT300V1KAS1812	240	300	360	800	10	1	100	1	0.6	1
AGDT350V1KAS1812	280	350	420	1000	10	1	100	1	0.6	1
AGDT400V1KAS1812	320	400	480	1000	12	1	100	1	0.6	1
AGDT420V1KAS1812	336	420	504	1000	12	1	100	1	0.6	1
AGDT470V1KAS1812	376	470	564	1200	12	1	100	1	0.6	1
AGDT600V1KAS1812	480	600	720	1400	15	1	100	1	0.6	1
AGDT90V2KAS1812	72	90	108	600	8	2	50	1	0.6	2
AGDT150V2KAS1812	120	150	180	600	8	2	50	1	0.6	2
AGDT200V2KAS1812	160	200	240	700	10	2	100	1	0.6	2
AGDT230V2KAS1812	184	230	280	700	10	2	100	1	0.6	2
AGDT300V2KAS1812	240	300	360	800	10	2	100	1	0.6	2
AGDT350V2KAS1812	280	350	420	1000	10	2	100	1	0.6	2
AGDT400VT2KAS1812	320	400	480	1000	12	2	100	1	0.6	2
AGDT420V2KAS1812	336	420	504	1000	12	2	100	1	0.6	2
AGDT470V2KAS1812	376	470	564	1200	12	2	100	1	0.6	2
AGDT600V2KAS1812	480	600	720	1400	15	2	100	1	0.6	2

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## **ELECTRICAL CHARACTERISTIC**

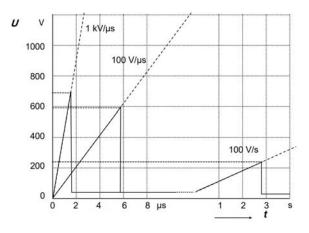
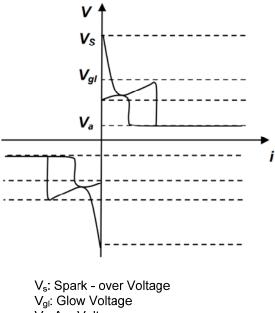


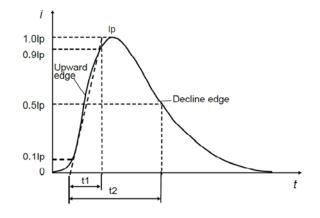
Figure 2. Spark-over Voltage Waveform



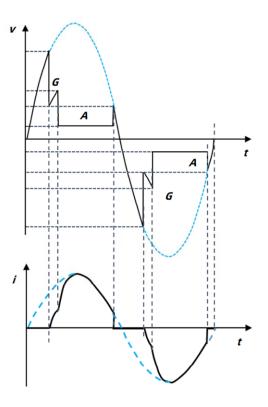
V<sub>a</sub>: Arc Voltage

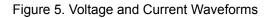
G : Glow Mode A : Arc Mode

Figure 4. Voltage vs. Current characteristics









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### **APPLICATION CIRCUITS**

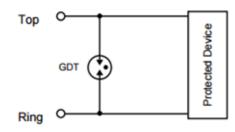


Figure 6. Signal Input Protection Circuit

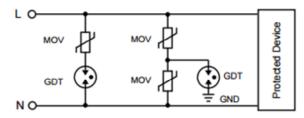


Figure 7. AC Power Input Protection Circuit

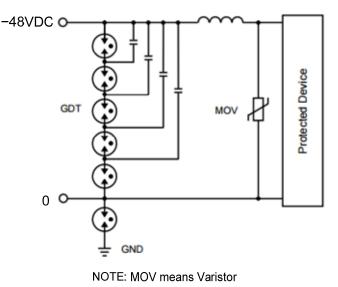
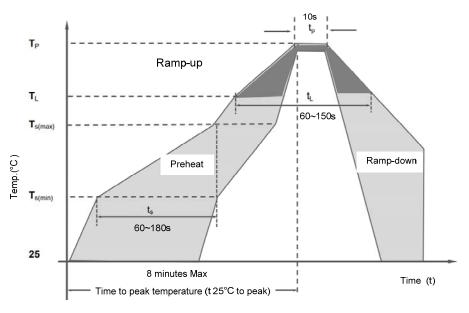


Figure 8. Power Supply Input Protection Circuit

# **RECOMANDED SOLDERING Profile and CONDITIONS**

During the soldering process, it is important to ensure that the GDT is not subjected to excessive thermal stress or mechanical stress, which can also damage the GDT. Care should be taken to avoid overheating the GDT and to avoid applying excessive force or pressure during the soldering process. It can be soldered by reflow oven or hand soldering.

### **Reflow Soldering**



#### Figure 9. Reflow Soldering



	Reflow Condition	Pb-Free Assembly		
	Temp. Min T <sub>s(min)</sub>	150°C		
Pre Heat	Temp. Max T <sub>s(max)</sub>	200°C		
	Time (Min to Max) $t_s$	(60 ~ 180)s		
Average ram	p up rate (Liquidus Temp $(T_L)$ to peak)	3°C/second max		
$T_{s(max)}$ to $T_LF$	Ramp-up Rate	5°C/second max		
Reflow	Temperature ( $T_L$ ) (Liquidus)	217°C		
	Temperature ( $t_L$ )	(60 ~ 150)s		
Peak Tempe	rature (T <sub>P</sub> )	(255 ~ 260)°C		
Time within 5	$5^{\circ}\text{C}$ of actual peak Temperature (t <sub>P</sub> )	≈ 10s		
Ramp-down	Rate	6°C/second max		
Time 25°C to	peak Temperature (T <sub>P</sub> )	8 minutes max		
Do not excee	ed	260°C		

#### **Hand Solder Parameters**

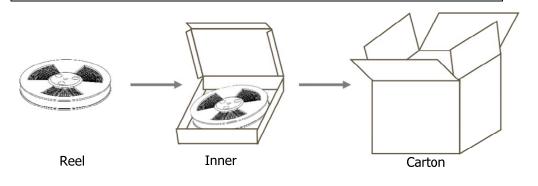
Items	Condition
Iron Temperature	350°C
Soldering Time	4s (Max.)
Space between Soldering Point and the Bottom of Product	2mm (Min.)

## **PACKAGING INFORMATION**

This GDT is packaged in reels: up to 2500/reel; inner boxes: 2 reels/inner box; and carton outer box: 8 inner box/carton box.

ltem	Reel	Inner	Carton	
Dimensions (mm)	Ф330 × 12.8	340 × 340 × 40	360 × 360 × 360	
Quantity (Pcs)	2500	5000	40000	

Note: The dimensions and quantity of packaging are for reference only.



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## DIMENSIONS

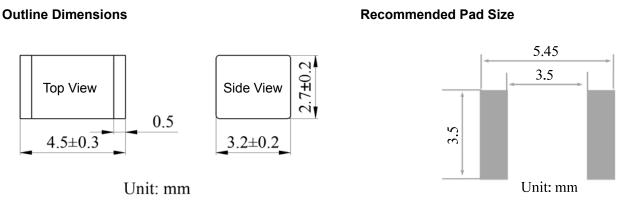


Figure 10. Outline Dimensions

Figure 11. Recommended PCB Pad Size

# NOTICE

- 1. It is important to carefully read and follow the warnings, cautions, and product- specific notes provided with electronic components. These instructions are designed to ensure the safe and proper use of the component and to prevent damage to the component or surrounding equipment. Failure to follow these instructions could result in malfunction or failure of the component, damage to surrounding equipment, or even injury or harm to individuals. Always take the necessary precautions and seek professional assistance if unsure about proper use or handling of electronic components.
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